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Kind regards,

Team Nexperia

# BZX84 series Voltage regulator diodes Rev. 6 — 6 March 2014

Product data sheet

## 1. Product profile

## 1.1 General description

Low-power voltage regulator diodes in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

The diodes are available in the normalized E24  $\pm 1$  % (BZX84-A),  $\pm 2$  % (BZX84-B) and approximately  $\pm 5$  % (BZX84-C) tolerance range. The series includes 37 breakdown voltages with nominal working voltages from 2.4 V to 75 V.

#### 1.2 Features and benefits

- Total power dissipation: ≤ 250 mW
- Three tolerance series: ±1 %, ±2 % and approximately ±5 %
- AEC-Q101 qualified

- Working voltage range: nominal 2.4 V to 75 V (E24 range)
- Non-repetitive peak reverse power dissipation: ≤ 40 W

## 1.3 Applications

General regulation functions

#### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	I <sub>F</sub> = 10 mA [1]	-	-	0.9	V
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$ [2]	-	-	250	mW

<sup>[1]</sup> Pulse test:  $t_p \leq 100~\mu s;~\delta \leq 0.02$ 



<sup>[2]</sup> Device mounted on a FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

# 2. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		14
2	n.c.	not connected		<u> </u>
3	K	cathode		A n.c.
			1 2	aaa-006592

# 3. Ordering information

Table 3. Ordering information

Type number	Package									
	Name	Description	Version							
BZX84 series[1]	TO-236AB	plastic surface-mounted package; 3 leads	SOT23							

<sup>[1]</sup> The series includes 37 breakdown voltages with nominal working voltages from 2.4 V to 75 V and  $\pm 1$  %,  $\pm 2$  % and  $\pm 5$  % tolerances.

# 4. Marking

Table 4. Marking codes

Type number	Marking code[1]	Type number	Marking code[1]
BZX84-A2V4	*50	BZX84-A18	KF*
BZX84-A2V7	*51	BZX84-A20	*C2
BZX84-A3V0	*52	BZX84-A22	KG*
BZX84-A3V3	*53	BZX84-A24	KH*
BZX84-A3V6	*C1	BZX84-A27	*75
BZX84-A3V9	*55	BZX84-A30	KJ*
BZX84-A4V3	*56	BZX84-A33	KK*
BZX84-A4V7	*57	BZX84-A36	*C3
BZX84-A5V1	*58	BZX84-A39	*C4
BZX84-A5V6	*59	BZX84-A43	*C5
BZX84-A6V2	*60	BZX84-A51	*C6
BZX84-A6V8	*61	BZX84-A75	*86
BZX84-A7V5	*62	BZX84-B2V4	*Z0
BZX84-A8V2	*63	BZX84-B2V7	*Z1
BZX84-A9V1	*64	BZX84-B3V0	*S1
BZX84-A10	*65	BZX84-B3V3	*S2
BZX84-A11	*04	BZX84-B3V6	*S3
BZX84-A12	*67	BZX84-B3V9	*S4
BZX84-A13	*C0	BZX84-B4V3	*S7
BZX84-A15	*69	BZX84-B4V7	*S8
BZX84-A16	KE*	BZX84-B5V1	*R1

 Table 4.
 Marking codes ...continued

Type number	Marking code <sup>[1]</sup>	Type number	Marking code <sup>[1]</sup>
BZX84-B5V6	*R2	BZX84-C3V9	*B3
BZX84-B6V2	*R5	BZX84-C4V3	*B6
BZX84-B6V8	*R6	BZX84-C4V7	Z1*
BZX84-B7V5	*R8	BZX84-C5V1	Z2*
BZX84-B8V2	*R9	BZX84-C5V6	Z3*
BZX84-B9V1	*T1	BZX84-C6V2	Z4*
BZX84-B10	*66	BZX84-C6V8	Z5*
BZX84-B11	*Z6	BZX84-C7V5	Z6*
BZX84-B12	*Z7	BZX84-C8V2	Z7*
BZX84-B13	*Z8	BZX84-C9V1	Z8*
BZX84-B15	*Z9	BZX84-C10	Z9*
BZX84-B16	*70	BZX84-C11	Y1*
BZX84-B18	*71	BZX84-C12	Y2*
BZX84-B20	*72	BZX84-C13	Y3*
BZX84-B22	*73	BZX84-C15	Y4*
BZX84-B24	*74	BZX84-C16	Y5*
BZX84-B27	*Z5	BZX84-C18	Y6*
BZX84-B30	*Z4	BZX84-C20	Y7*
BZX84-B33	*Y1	BZX84-C22	Y8*
BZX84-B36	*Y2	BZX84-C24	Y9*
BZX84-B39	*S0	BZX84-C27	*T2
BZX84-B43	*S5	BZX84-C30	*T5
BZX84-B47	*S6	BZX84-C33	*T6
BZX84-B51	*S9	BZX84-C36	*T7
BZX84-B56	*R0	BZX84-C39	*T8
BZX84-B62	*R3	BZX84-C43	*B4
BZX84-B68	*R4	BZX84-C47	*B5
BZX84-B75	*R7	BZX84-C51	*B7
BZX84-C2V4	*T3	BZX84-C56	*B8
BZX84-C2V7	*T4	BZX84-C62	*B9
BZX84-C3V0	*T9	BZX84-C68	*B0
BZX84-C3V3	*B1	BZX84-C75	*A1
BZX84-C3V6	*B2	-	-

<sup>[1] \* =</sup> placeholder for manufacturing site code

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
IF	forward current		-	200	mA
P <sub>ZSM</sub>	non-repetitive peak reverse power dissipation	[1]	-	40	W
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$ [2]	-	250	mW
T <sub>amb</sub>	ambient temperature		-	150	°C
T <sub>stg</sub>	storage temperature		-55	+150	°C
T <sub>j</sub>	junction temperature		-65	+150	°C

<sup>[1]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_j = 25 \,^{\circ}C$  before surge

## 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>1]</u>	-	-	500	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point	1	2]	-	-	330	K/W

<sup>[1]</sup> Device mounted on a FR4 PCB, single-sided copper, tin-plated and standard footprint.

## 7. Characteristics

**Table 7. Characteristics** 

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	I <sub>F</sub> = 10 mA [1]	-	-	0.9	V

<sup>[1]</sup> Pulse test:  $t_p \le 100~\mu s;~\delta \le 0.02$ 

<sup>[2]</sup> Device mounted on a FR4 PCB, single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Soldering point of cathode tab.

Table 8. Characteristics per type; BZX84-A2V4 to BZX84-C24

 $T_i = 25$  °C unless otherwise specified.

BZX84- xxx		_	ng je		rential	resista	ance	curre	$\begin{array}{ll} \text{Reverse} & \text{Temperate} \\ \text{current} & \text{coefficien} \\ I_R \; (\mu A) & S_Z \; (\text{mV/K}) \end{array}$				-			
		I <sub>Z</sub> = 5	mA	I <sub>Z</sub> = 1	mA	$I_Z = 5$	mA			I <sub>Z</sub> = 5	mA			I <sub>ZSM</sub> (A)[2]		
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max		
2V4	Α	2.37	2.43	275	600	70	100	50	1	-3.5	-1.6	0	450	6.0		
	В	2.35	2.45													
	С	2.2	2.6													
2V7	Α	2.67	2.73	300	600	75	100	20	1	-3.5	-2.0	0	450	6.0		
	В	2.65	2.75													
	С	2.5	2.9													
3V0	Α	2.97	3.03	325	600	80	95	10	1	-3.5	-2.1	0	450	6.0		
	В	2.94	3.06													
	С	2.8	3.2													
3V3	Α	3.26	3.34	350	600	85	95	5	1	-3.5	-2.4	0	450	6.0		
	В	3.23	3.37													
	С	3.1	3.5													
3V6	Α	3.56	3.64	375	600	85	90	5	1	-3.5	-2.4	0	450	6.0		
	В	3.53	3.67													
	С	3.4	3.8													
3V9	Α	3.86	3.94	400	600	85	90	3	1	-3.5	-2.5	0	450	6.0		
	В	3.82	3.98													
	С	3.7	4.1													
4V3	Α	4.25			410		600	80	90	3	1	-3.5	-2.5	0	450	6.0
	В	4.21	4.39													
	С	4.0	4.6													
4V7	Α	4.65	4.75	425	500	50	80	3	2	-3.5	-1.4	0.2	300	6.0		
	В	4.61	4.79													
	С	4.4	5.0													
5V1	Α	5.04	5.16	400	480	40	60	2	2	-2.7	-0.8	1.2	300	6.0		
	В	5.0	5.2													
	С	4.8	5.4													
5V6	Α	5.54	5.66	80	400	15	40	1	2	-2.0	1.2	2.5	300	6.0		
	В	5.49	5.71													
	С	5.2	6.0													
6V2	Α	6.13	6.27	40	150	6	10	3	4	0.4	2.3	3.7	200	6.0		
	В	6.08	6.32													
	С	5.8	5.8 6.6													
6V8	Α	6.73	6.87	30	80	6	15	2	4	1.2	3.0	4.5	200	6.0		
	В	6.66	6.94													
С	С	6.4	7.2													

**Product data sheet** 

Table 8. Characteristics per type; BZX84-A2V4 to BZX84-C24 ...continued

 $T_i = 25$  °C unless otherwise specified.

BZX84- xxx	Sel	Worki voltag V <sub>Z</sub> (V)	e	Differ		resist	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		ent	icient	)	Diode capacitance C <sub>d</sub> (pF)[1]	Non-repetitive peak reverse current	
		I <sub>Z</sub> = 5	mA	I <sub>Z</sub> = 1	mA	$I_Z = 5$	mA			$I_Z = 5$	mA			I <sub>ZSM</sub> (A)[2]
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max
7V5	Α	7.42	7.58	30	80	6	15	1	5	2.5	4.0	5.3	150	4.0
	В	7.35	7.65											
	С	7.0	7.9											
8V2	Α	8.11	8.29	40	80	6	15	0.7	5	3.2	4.6	6.2	150	4.0
	В	8.04	8.36											
	С	7.7	8.7											
9V1	Α	9	9.2	40	100	6	15	0.5	6	3.8	5.5	7.0	150	3.0
	В	8.92	9.28											
	С	8.5	9.6											
10	Α	9.9	10.1	50	150	8	20	0.2	7	4.5	6.4	8.0	90	3.0
	В	9.8	10.2											
	С	9.4	10.6											
11	Α	10.8	11.11	50	150	10	20	0.1	8	5.4	7.4	9.0	85	2.5
	В	10.8	11.2											
	С	10.4	11.6											
12	Α	11.88	12.12	50	150	10	25	0.1	8	6.0	8.4	10.0	85	2.5
	В	11.8	12.2											
	С	11.4	12.7											
13	Α	12.87	13.13	50	170	10	30	0.1	8	7.0	9.4	11.0	80	2.5
	В	12.7	13.3	+										
	С	12.4	14.1											
15	Α	14.85	15.15	50	200	10	30	0.05	10.5	9.2	11.4	13.0	75	2.0
	В	14.7	15.3											
	С	13.8	15.6											
16	Α	15.84	16.16	50	200	10	40	0.05	11.2	10.4	12.4	14.0	75	1.5
	В	15.7	16.3											
	С	15.3	17.1											
18	Α	17.82	18.18	50	225	10	45	0.05	12.6	12.4	14.4	16.0	70	1.5
	В	17.6	18.4											
	С	16.8	19.1											
20	Α	19.8	20.2	60	225	15	55	0.05	14	14.4	16.4	18.0	60	1.5
	В	19.6	20.4											
	С	18.8	21.2											
22	Α	21.78	22.22	60	250	20	55	0.05	15.4	16.4	18.4	20.0	60	1.25
	В	21.6	22.4			20		0.00						
	С	20.8	23.3											

Table 8. Characteristics per type; BZX84-A2V4 to BZX84-C24 ...continued

 $T_i = 25$  °C unless otherwise specified.

BZX84- xxx	Sel	Working voltage V <sub>Z</sub> (V)		Differ r <sub>dif</sub> (Ω	rential 2)	resista	ince	Rever curre I <sub>R</sub> (μΑ	nt	Tempo coeffi S <sub>Z</sub> (m			Diode capacitance C <sub>d</sub> (pF)[1]	Non-repetitive peak reverse current		
		$I_Z = 5$ 1	nΑ	I <sub>Z</sub> = 1	mA	$I_Z = 5$	mA		I <sub>Z</sub> = 5		I <sub>Z</sub> = 5 mA			I <sub>ZSM</sub> (A)[2]		
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max		
24	Α	23.76	24.24	60	250	25	70	0.05	16.8	18.4	20.4	22.0	55	1.25		
	В	23.5	24.5	1												
	С	22.8	25.6	1												

<sup>[1]</sup>  $f = 1 \text{ MHz}; V_R = 0 \text{ V}$ 

Table 9. Characteristics per type; BZX84-A27 to BZX84-C75

 $T_j = 25$  °C unless otherwise specified.

BZX84- xxx	Sel	Working voltag V <sub>Z</sub> (V)	_	Differ	rential 2)	resista	ance	Reve curre I <sub>R</sub> (μΑ	nt		erature icient IV/K)	•	Diode capacitance C <sub>d</sub> (pF)[1]	Non-repetitive peak reverse current I <sub>ZSM</sub> (A) <sup>[2]</sup> Max  1.0  1.0  0.9  0.8  0.7  0.6			
		I <sub>Z</sub> = 2 i	mA	$I_Z = 0$	.5 mA	$I_Z = 2 \text{ mA}$				I <sub>Z</sub> = 2	mA			I <sub>ZSM</sub> (A)[2]			
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max			
27	Α	26.73	27.27	65	300	25	80	0.05	18.9	21.4	23.4	25.3	50	1.0			
	В	26.5	27.5														
	С	25.1	28.9														
30	Α	29.7	30.30	70	300	30	80	0.05	21	24.4	26.6	29.4	50	1.0			
	В	29.4	30.6														
	С	28.0	32.0														
В	Α	32.67	33.33	75	325	35	80	0.05	23.1	27.4	29.7	33.4	45	0.9			
	В	32.3	33.7														
	С	31.0	35.0														
36	Α	35.64	36.36	80	350	35	90	0.05	25.2	30.4	33.0	37.4	45	0.8			
	В	35.3	36.7		Ī												
	С	34.0	38.0														
39	Α	38.61	39.39	80	350	40	130	0.05	27.3	33.4	36.4	41.2	45	0.7			
	В	38.2	39.8														
	С	37.0	41.0														
43	Α	42.57	43.43	85	375	45	150	0.05	30.1	37.6	41.2	46.6	40	0.6			
	В	42.1	43.9														
	С	40.0	46.0														
47	В	46.1	47.9	85	375	50	170	0.05	32.9	42.0	46.1	51.8	40	0.5			
	С	44.0	50.0														
51	Α	50.49	51.51	90	400	60	180	0.05	35.7	46.6	51.0	57.2	40	0.4			
	В	50.0	52.0	1			1.22										
	C 48.0 54.0	1															

<sup>[2]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_j = 25 \, ^{\circ}C$  before surge

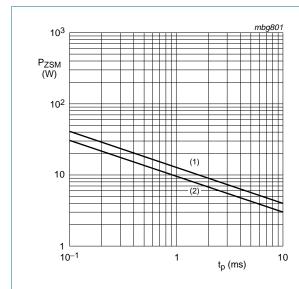
 Table 9.
 Characteristics per type;
 BZX84-A27 to BZX84-C75 ...continued

 $T_i = 25$  °C unless otherwise specified.

BZX84- xxx	Sel	Working voltage V <sub>Z</sub> (V) I <sub>Z</sub> = 2 mA		Differential resistance $r_{dif} (\Omega)$			Reverse current I <sub>R</sub> (μA)		Temperature coefficient S <sub>Z</sub> (mV/K)			Diode capacitance C <sub>d</sub> (pF)[1]	Non-repetitive peak reverse current	
				$I_Z = 0.5 \text{ mA}$		I <sub>Z</sub> = 2 mA				I <sub>Z</sub> = 2 mA			I <sub>ZSM</sub> (A)[2]	
		Min	Max	Тур	Max	Тур	Max	Max	V <sub>R</sub> (V)	Min	Тур	Max	Max	Max
56	В	54.9	57.1	100	425	70	200	0.05	39.2	52.2	57.0	63.8	40	0.3
	С	52.0	60.0											
62	В	60.8	63.2	120	450	80	215	0.05	43.4	58.8	64.4	71.6	35	0.3
	С	58.0	66.0											
68	В	66.6	69.4	150	475	90	240	0.05	47.6	65.6	71.7	79.8	35	0.25
	С	64.0	72.0											
75	Α	74.25	75.75	170	500	95 2	255	0.05	52.5	73.4	80.2	88.6	35	0.20
	В	73.5	76.5											
	С	70.0	79.0											

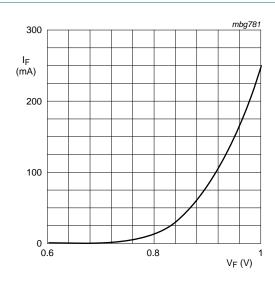
<sup>[1]</sup>  $f = 1 \text{ MHz}; V_R = 0 \text{ V}$ 

<sup>[2]</sup>  $t_p = 100 \mu s$ ; square wave;  $T_j = 25 \, ^{\circ} C$  before surge



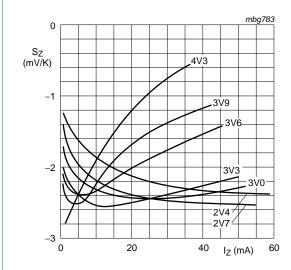
- (1)  $T_i = 25$  °C (before surge)
- (2)  $T_i = 150 \,^{\circ}\text{C}$  (before surge)

Fig 1. Non-repetitive peak reverse power dissipation as a function of pulse duration; maximum values



T<sub>j</sub> = 25 °C

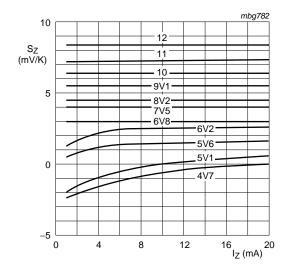
Fig 2. Forward current as a function of forward voltage; typical values



BZX84-A/B/C2V4 to BZX84-A/B/C4V3

 $T_j = 25 \,^{\circ}\text{C}$  to 150  $^{\circ}\text{C}$ 

Fig 3. Temperature coefficient as a function of working current; typical values



BZX84-A/B/C4V7 to BZX84-A/B/C12

 $T_j = 25 \,^{\circ}\text{C}$  to 150  $^{\circ}\text{C}$ 

Fig 4. Temperature coefficient as a function of working current; typical values

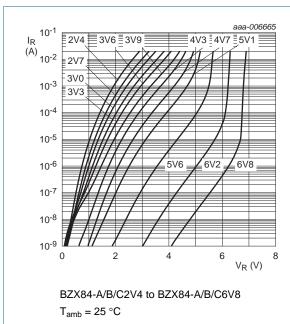
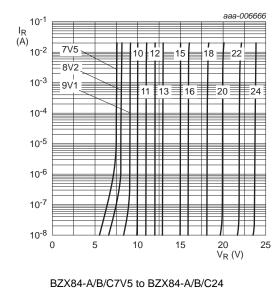
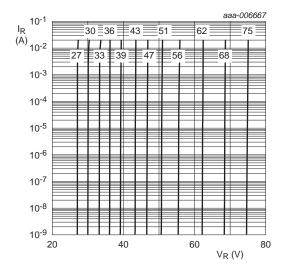


Fig 5. Reverse current as a function of reverse voltage; typical values



 $T_{amb} = 25 \, ^{\circ}C$ 

Fig 6. Reverse current as a function of reverse voltage; typical values



BZX84-A/B/C27 to BZX84-A/B/C75

 $T_{amb} = 25 \, ^{\circ}C$ 

Reverse current as a function of reverse voltage; typical values Fig 7.

#### **Test information** 8.

## **Quality information**

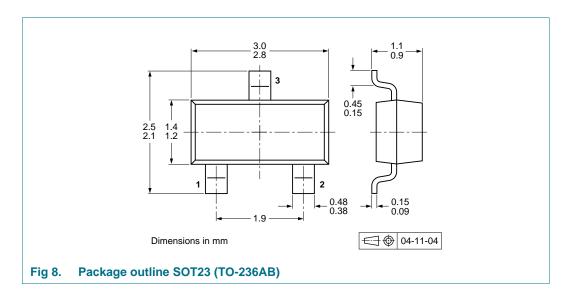
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

BZX84 SER

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# 9. Package outline



# 10. Packing information

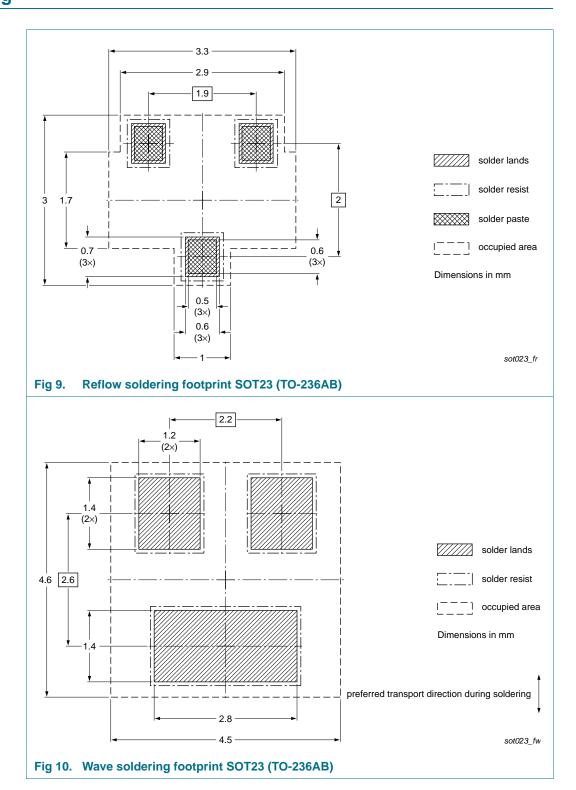
Table 10. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity		
			3000	10000	
BZX84 series <sup>[2]</sup>	SOT23 (TO-236AB)	4 mm pitch, 8 mm tape and reel	-215	-235	

- [1] For further information and the availability of packing methods, see  $\underline{\text{Section 14}}$ .
- [2] The series includes 37 breakdown voltages with nominal working voltages from 2.4 V to 75 V and  $\pm 1$  %,  $\pm 2$  % and  $\pm 5$  % tolerances.

# 11. Soldering



# 12. Revision history

## Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BZX84_SER v.6	20140306	Product data sheet	-	BZX84_SER v.5
Modifications:	Descriptive title	of the document corrected		
BZX84_SER v.5	20130918	Product data sheet	-	BZX84_SER v.4
BZX84_SER v.4	20130322	Product data sheet	-	BZX84_SERIES v.3
BZX84_SERIES v.3	20030410	Product data sheet	-	BZX84 v.2
BZX84 v.2	19990518	Product specification	-	BZX84 v.1
BZX84 v.1	19960426	Product specification	-	-

## 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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**BZX84** series

#### Voltage regulator diodes

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